

Variant: 001  
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 TID #: PMP10711



**PMP10711 REV 1 Bill of Materials**

Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	PCB	1		PMP10711	Any	Printed Circuit Board	
2	C1	1	0.1uF	C0603C104M4RACTU	Kemet	CAP, CERM, 0.1 $\mu$ F, 16 V, +/- 20%, X7R, 0603	0603
3	GND 1, TP1, TP2, TP3, TP4, TP5, TP6, TPx, TPx1, TPx2	10	Double	1502-2	Keystone	Terminal, Turret, TH, Double	Keystone1502-2
4	R1, R2, R3, R4, R5, R6	6	100k	Std	Std	Resistor, Chip, 1/16W, 1%	0402
5	U1	1		SN74AHC1G32DRLR	Texas Instruments	Single 2-Input Positive-OR Gate, DRL0005A	DRL0005A
6	U2	1		SN74AHC1G08DRL	Texas Instruments	Single 2-Input Positive-AND Gate, DRL0005A	DRL0005A
7	U3, U4	2		LM3880MF-1AA/NOPB	Texas Instruments	Power Sequencer, 6-pin SOT-23, Pb-Free	MF06A
8	FID1, FID2, FID3	0		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial

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